

new 6-17-99 / D581-40

09/331334

ASSIGNMENT RECORD

08-10-1999

Patents Only

80 RECEIVED 17 JUN 1999

To the Honorable Commission
Please record the attached original



101113021

9

Attorney Docket No. 5576-102

1. Name of conveying party(ies):

Noriya Hayashi
Shunichi Hayashi

2. Name and address of receiving party(ies):

Mitsubishi Heavy Industries, Ltd.
5-1, Marunouchi 2-chome
Chiyoda-ku, Tokyo
JAPAN

Additional name(s) of conveying party(ies) attached? ___ Yes X No

3. Nature of conveyance:

X Assignment
___ Merger
___ Security Agreement
___ Change of Name
___ Other _____

Execution Date: May 12, 1999

Additional name(s) & address(es) attached? ___ Yes X No

4. Application Serial No.

Patent No.

If this document is being filed together with a new application, the execution date of the application is: May 12, 1999

Additional numbers attached? ___ Yes X No

5. Name and address of party to whom correspondence concerning document should be mailed:

Robert J. Smith, Esq.
Myers Bigel Sibley & Sajovec
P. O. Box 37428
Raleigh NC 27627

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41) \$40.00
X Enclosed
___ Authorized to be charged to deposit account

8. Deposit account number: 50-0220

DO NOT USE THIS SPACE

9. Statement and signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert J. Smith, Reg #40,820

Name of Person Signing

Signature

June 17, 1999

Date

Total number of pages including cover sheet, attachments and document: 2

ASSIGNMENT

WHEREAS:

Noriya HAYASHI and Shunichi HAYASHI of c/oNagoya Research & Development Center, MITSUBISHI HEAVY INDUSTRIES, LTD. 1, Aza Takamichi, Iwatsuka-cho, Nakamura-ku, Nagoya-shi, Aichi-ken, Japan (all (hereinafter referred to as ASSIGNOR), has invented and own a certain invention entitled: NOVEL RESIN CURING METHOD ENABLING THE ENERGY RADIATION CURING OF RESINS CONTAINING AN ENERGY RADIATION SCREENING SUBSTANCE, ** for which application for United States Letters Patent identified as _____

_____ has been executed on the
12th day of May, 19 99, and,

WHEREAS:

****COMPOSITIONS, MOLDED ARTICLES AND
MOLDING METHODS**

MITSUBISHI HEAVY INDUSTRIES, LTD. of 5-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan (hereinafter referred to as "ASSIGNEE"), has equitable rights in and to this invention and desires to confirm such rights and to acquire all right, title and interest in and to this invention, including any and all United States Letters Patent or similar legal protection to be obtained therefor.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby sells, assigns, and transfers to said ASSIGNEE, its successors and assigns, all right, title and interest in and to said invention, including any and all United States Letters Patent which may be granted therefor and any and all extensions, continuations, divisions, renewals, substitutes or reissues thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

ASSIGNOR further covenants and agrees, upon request, to execute any instrument which said ASSIGNEE desires to carry this assignment in effect, and perfect the title transferred hereby, or to file or prosecute any of the above-mentioned United States applications.

And the Commissioner of Patents of the United States is hereby authorized to issue Letters Patent on said above-named application and on any continuation, substitute or division thereof to said ASSIGNEE.

IN TESTIMONY WHEREOF, I/We have hereunto set hand and seal this 12th day of
May., 1999 .

ASSIGNOR:

Noriya Hayashi
 Noriya HAYASHI

Shunichi Hayashi
 Shunichi HAYASHI

Witnesses:

Yukihiro Sakaguchi
 Yukihiro SAKAGUCHI

Tetsuo Uwaji
 Tetsuo UWAJI